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PATENT NUMBER and  
ISSUE DATE

U.S. UTILITY Patent Application

APPL N°/IM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10062650	01/31/2002	438		2812	2825 LUU CHUON

**\*\*APPLICANTS:** McLellan Neil; Fan Chun; Combs Edward; Cheung Tsang; Keung Chow; Labeeb Sadak;

**\*\*CONTINUING DATA VERIFIED:**

**\*\* FOREIGN APPLICATIONS VERIFIED:**

PG-PUB ☐ DO NOT PUBLISH ☐

RESCIND ☐

Foreign priority claimed ☐ yes ☐ no

35 USC 119 conditions met ☐ yes ☐ no

Verified and Acknowledged Examiners's Initials \*

ATTORNEY DOCKET NO

36080.01101

**TITLE :** Encapsulated integrated circuit package and method of manufacturing an integrated circuit package

U.S. DEPT. OF COMM./PAT. & TM-PTO-438 (Rev. 12-94)

<b>NOTICE OF ALLOWANCE MAILED</b>		<b>CLAIMS ALLOWED</b>	
		Total Claims	
<b>ISSUE FEE</b>		Assistant Examiner	
Amount Due	Date Paid		
		Primary Examiner	
<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>		Application Examiner	
		<b>PREPARED FOR ISSUE</b>	
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